ULTRA-SMALL SUPPLY VOLTAGE SUPERVISORS

Check for Samples: TPS3800-xx, TPS3801-xx, TPS3802-xx

FEATURES

- **Small, 5-Pin SC-70 (SOT-323) Package**
- **Supply Current of 9 μA**
- **Power-On Reset Generator With Fixed Delay Time**
  - **TPS3800 = 100 ms**
  - **TPS3801 = 200 ms**
  - **TPS3802 = 400 ms**
- **Precision Supply Voltage Monitor 1.8 V, 2.5 V, 2.7 V, 3 V, 3.3 V, 5 V, and Adjustable**
- **Manual Reset Input (Except TPS3801-01)**
- **Temperature Range: –40°C to +85°C**

APPLICATIONS

- **Applications Using DSPs, Microcontrollers, or Microprocessors**
- **Wireless Communication Systems**
- **Portable/Battery-Powered Equipment**
- **Programmable Controls**
- **Intelligent Instruments**
- **Industrial Equipment**
- **Notebook/Desktop Computers**
- **Automotive Systems**

DESCRIPTION

The TPS380x family of supervisory circuits monitor supply voltages to provide circuit initialization and timing supervision, primarily for DSPs and other processor-based systems.

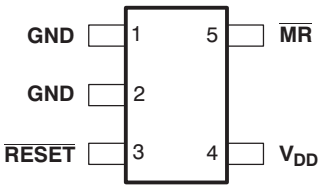
These devices assert a push-pull $\overline{\text{RESET}}$ signal when the SENSE (adjustable version) or V_{DD} (fixed version) drops below a preset threshold. The $\overline{\text{RESET}}$ output remains asserted for the factory programmed delay time after the SENSE or V_{DD} return above its threshold.

The TPS380x devices, except the TPS3801-01, incorporate a manual reset input ($\overline{\text{MR}}$). A low level at $\overline{\text{MR}}$ causes $\overline{\text{RESET}}$ to become active.

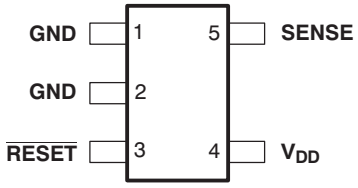
The TPS380x uses a precision reference to achieve an overall threshold accuracy of 2%—2.5%. These devices are available in a 5-pin SC-70 package, which is only about half the size of a 5-pin SOT-23 package.

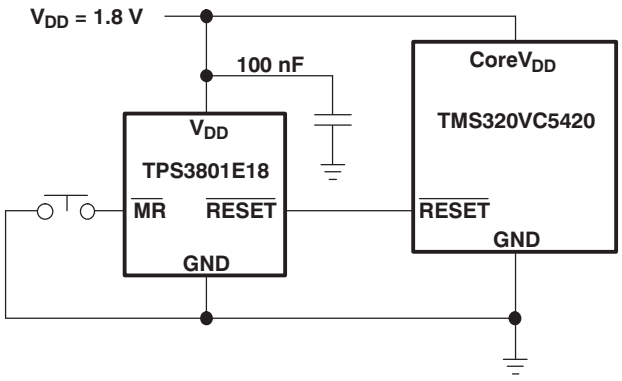
The TPS380x devices are fully specified over a temperature range of –40°C to +85°C.

TPS380x . . . DCK PACKAGE
(TOP VIEW)



TPS3801–01 . . . DCK PACKAGE
(TOP VIEW)





These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

AVAILABLE OPTIONS(1)

T_A	DEVICE NAME	THRESHOLD VOLTAGE	TYP DELAY TIME	MARKING
–40°C to 85°C	TPS3801-01DCK	Adjustable (V_{ref} = 1.14 V)	200 ms	ARF
	TPS3801E18DCK	1.71 V	200 ms	ARE
	TPS3801J25DCK	2.25 V	200 ms	NJA
	TPS3800G27DCK	2.5 V	95 ms	ARI
	TPS3801L30DCK	2.64 V	200 ms	NPA
	TPS3801K33DCK	2.93 V	200 ms	NWA
	TPS3802L30DCK	2.64 V	380 ms	ASA
	TPS3802K33DCK	2.93 V	380 ms	ARK
	TPS3801T50DCK	4.00 V	25 ms	AVI
	TPS3801I50DCK	4.55 V	200 ms	NSA

(1) For the most current package and ordering information, see the Package Option Addendum at the end of this data sheet, or refer to our web site at www.ti.com.

ABSOLUTE MAXIMUM RATINGS(1) (2)

Over operating free-air temperature range (unless otherwise noted).

	UNIT
Supply voltage, V_{DD}	7 V
SENSE	–0.3 V to 5 V
All other pins	–0.3 V to 7 V
$\overline{MR}$	–0.3 V to V_{DD} + 0.3 V
$\overline{RESET}$	–0.3 V to V_{DD} + 0.3 V
Maximum low-output current, I_{OL}	5 mA
Maximum high-output current, I_{OH}	–5 mA
Input-clamp current, I_{IK} (V_I < 0 or V_I > V_{DD})	±20 mA
Output-clamp current, I_{OK} (V_O < 0 or V_O > V_{DD})	±20 mA
Operating junction temperature range, T_J (3)	–40°C to +85°C
Storage temperature range, T_{stg}	–65°C to +150°C

(1) Stresses beyond those listed under *absolute maximum ratings* may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under *recommended operating conditions* is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.
(2) All voltage values are with respect to GND. For reliable operation, the device should not be operated at 7 V for more than t = 1000h continuously.
(3) Due to the low dissipation power of this device, it is assumed that $T_J = T_A$.

RECOMMENDED OPERATING CONDITIONS

		MIN	MAX	UNIT
Supply voltage, V_{DD}	TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, TPS3801T50	2	6	V
	All other devices	1.6	4	
SENSE		0	See (1)	V
Input voltage, V_I		0	V_{DD} +0.3	V
High-level input voltage, V_{IH}		0.7 × V_{DD}	V_{DD} +0.3	V
Low-level input voltage, V_{IL}			0.3 × V_{DD}	V
Input transition rise and fall rate at $\overline{MR}$, Δt/ΔV			100	ns/V
Pull-up resistor value, $\overline{RESET}$		$\frac{V_{Pull\text{-}up}}{50\mu A}$		Ω
Operating free-air temperature range, T_A		–40	+85	°C

(1) Maximum = V_{DD} + 0.3 or 4.5 V, whichever is greater.

ELECTRICAL CHARACTERISTICS

Over –40°C to +85°C free-air temperature range (unless otherwise noted).

PARAMETER			TEST CONDITIONS	TPS3800-xx, TPS3801-xx, TPS3802-xx			UNIT
				MIN	TYP	MAX	
V_{OH}	High-level output voltage ($\overline{RESET}$)		V_{DD} = 1.6 V to 6 V I_{OH} = –500 µA	V_{DD} –0.2			V
			V_{DD} = 3.3 V I_{OH} = –2 mA	V_{DD} –0.4			
			V_{DD} = 6 V I_{OH} = –4 mA (1)	V_{DD} –0.4			
V_{OL}	Low-level output voltage ($\overline{RESET}$)		V_{DD} = 1.6 V to 6 V, I_{OL} = 500 µA			0.2	V
			V_{DD} = 3.3 V, I_{OL} = 2 mA			0.4	
			V_{DD} = 6 V, I_{OL} = 4 mA (1)			0.4	
	Power-up reset voltage(2)		V_{DD} ≥ 1.1 V, I_{OL} = 50 µA			0.2	V
$V_{IT–}$	Negative-going input threshold voltage(3)	TPS380x-01	T_A = –40°C to 85°C	1.117	1.14	1.163	V
		TPS380xE18		1.67	1.71	1.75	
		TPS380xJ25		2.2	2.25	2.3	
		TPS380xG27		2.45	2.5	2.55	
		TPS380xL30		2.58	2.64	2.7	
		TPS380xK33		2.87	2.93	2.99	
		TPS380xI50		4.45	4.55	4.65	
		TPS380xT50		3.92	4	4.08	
V_{hys}	Threshold hysteresis	TPS380x-01			15		mV
		TPS380xx18			25		
		TPS380xx25			30		
		TPS380xx27			35		
		TPS380xx30			35		
		TPS380xx33			40		
		TPS380xx50			60		
I_{IH}	High-level input current ($\overline{MR}$)		$\overline{MR}$ = 0.7×V_{DD}, V_{DD} = 6 V	–40	–60	–100	µA
I_{IL}	Low-level input current ($\overline{MR}$)		$\overline{MR}$ = 0 V, V_{DD} = 6 V	–130	–200	–340	
I_I	Input current (SENSE)			–25		25	nA
I_{DD}	Supply current	TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, TPS3801T50	V_{DD} = 2 V, $\overline{MR}$ and output unconnected		9	12	µA
			V_{DD} = 6 V, $\overline{MR}$ and output unconnected		20	25	
		TPS3801-01	V_{DD} = 1.6 V, SENSE = 0 V to V_{DD}, output unconnected		7	10	
			V_{DD} = 4 V, SENSE = 0 V to V_{DD}, output unconnected		9	12	
		TPS3801E18, TPS3800G27, TPS3802K33, TPS3802L30	V_{DD} = 1.6 V, $\overline{MR}$ and output unconnected		8	11	
			V_{DD} = 4 V, $\overline{MR}$ and output unconnected		13	18	
C_i	Input capacitance		V_I = 0 V to V_{DD}		5		pF

(1) Only valid for the TPS3801J25, TPS3801L30, TPS3801K33, TPS3801I50, and TPS3801T50.
(2) The lowest supply voltage at which $\overline{RESET}$ becomes active. $t_{r,\ VDD}$ ≥ 15 µs/V.
(3) To ensure the best stability of the threshold voltage, a bypass capacitor (0.1-µF ceramic) should be placed near the supply terminals.

TIMING REQUIREMENTS

at R_L = 1 MΩ, C_L = 50 pF, T_A = +25°C

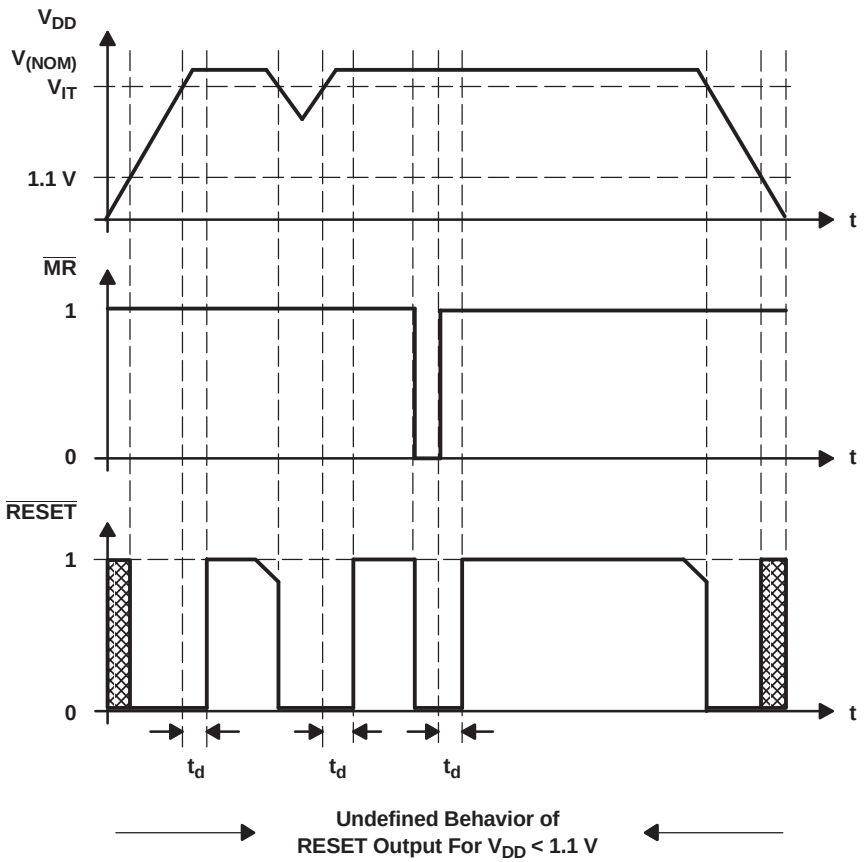
PARAMETER		TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_w Pulse width	at SENSE	V_{DD} = 1.6 V, V_{IH} = 1.1 × V_{IT-}, V_{IL} = 0.9 × V_{IT-}	1			µs
	at V_{DD}	V_{DD} = V_{IT-} + 0.2 V, V_{DD} = V_{IT-} –0.2 V	3			
	at $\overline{MR}$	V_{DD} ≥ V_{IT-} + 0.2 V, V_{IL} = 0.3 × V_{DD}, V_{IH} = 0.7 × V_{DD}	100			ns

SWITCHING CHARACTERISTICS

at R_L = 1 MΩ, C_L = 50 pF, T_A = +25°C

PARAMETER			TEST CONDITIONS	MIN	TYP	MAX	UNIT
t_d	$\overline{RESET}$ recovery delay time	TPS3801T50	V_{DD} ≥ V_{IT-} + 0.2 V, $\overline{MR}$ ≥ 0.7 × V_{DD} See timing diagram	15	25	35	ms
		TPS3800		60	95	140	
		TPS3801		120	200	280	
		TPS3802		240	380	560	
t_{PHL}	Propagation (delay) time, high-to-low-level output	$\overline{MR}$ to $\overline{RESET}$ delay	V_{DD} ≥ V_{IT-} + 0.2 V, V_{IL} = 0.3 × V_{DD}, V_{IH} = 0.7 × V_{DD}		15		ns
		V_{DD} to $\overline{RESET}$ delay	V_{IL} = V_{IT-} – 0.2 V, V_{IH} = V_{IT-} + 0.2 V		1		µs
		SENSE to $\overline{RESET}$					

TIMING DIAGRAM



NOTE: $\overline{RESET}$ should not be forced high during the power-up sequence (until V_{DD} > 1.1 V).

FUNCTIONAL BLOCK DIAGRAMS

FUNCTION/TRUTH TABLE, TPS380x

$\overline{MR}$	$V_{DD}>V_{IT}$	$\overline{RESET}$
L	0	L
L	1	L
H	0	L
H	1	H

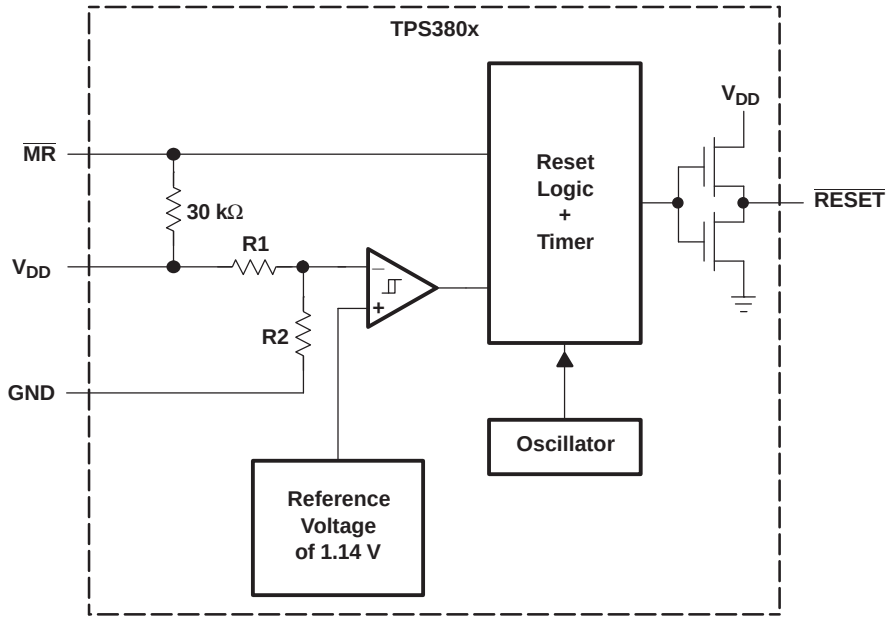


Figure 1.

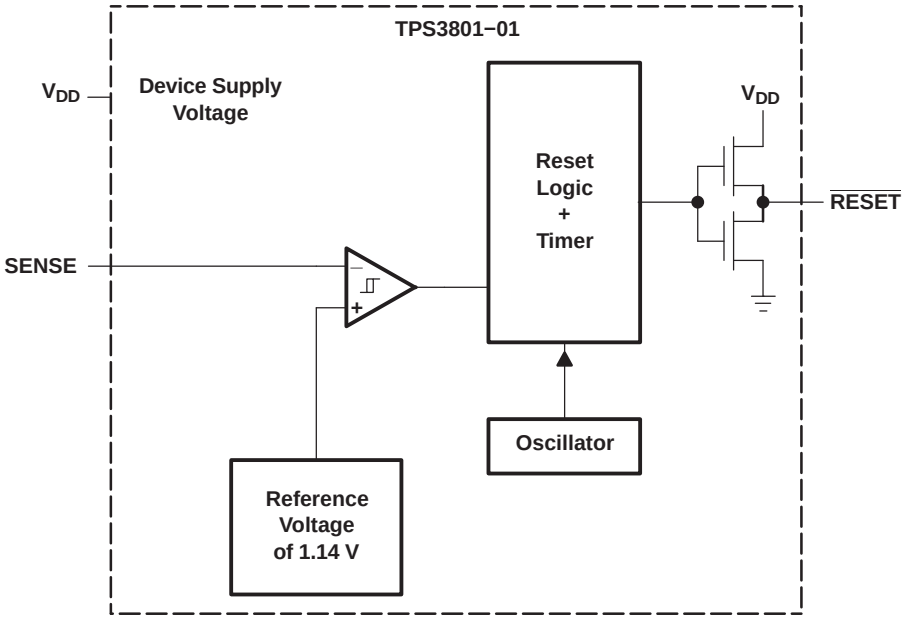


Figure 2.

TYPICAL CHARACTERISTICS

LOW-LEVEL OUTPUT VOLTAGE vs LOW-LEVEL OUTPUT CURRENT

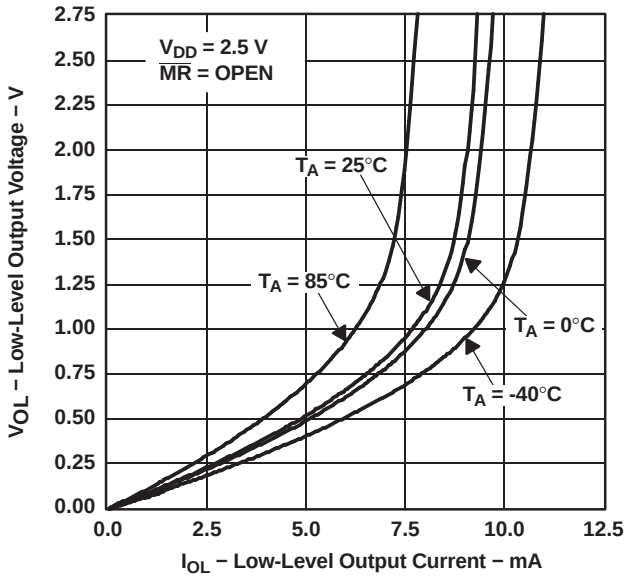


Figure 3.

SUPPLY CURRENT vs SUPPLY VOLTAGE

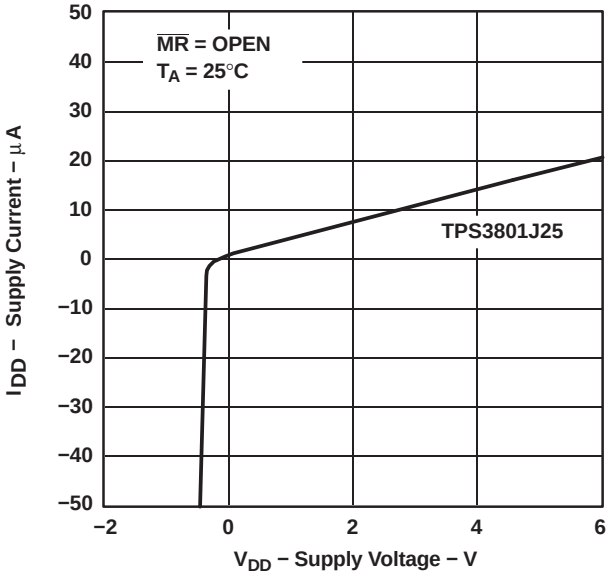


Figure 4.

HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

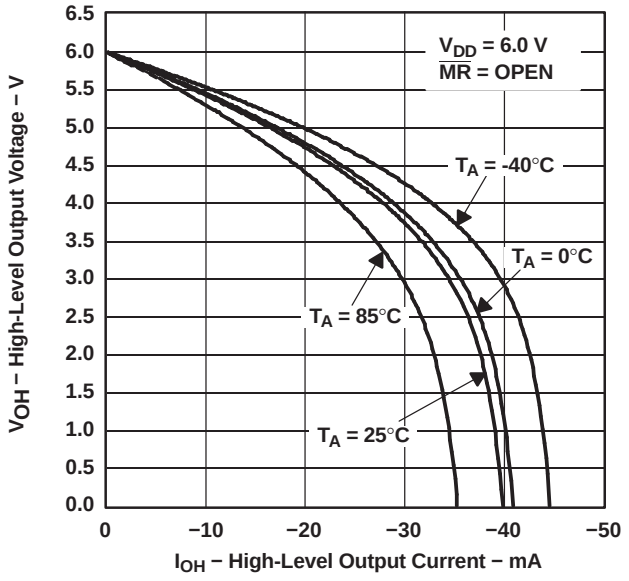


Figure 5.

HIGH-LEVEL OUTPUT VOLTAGE vs HIGH-LEVEL OUTPUT CURRENT

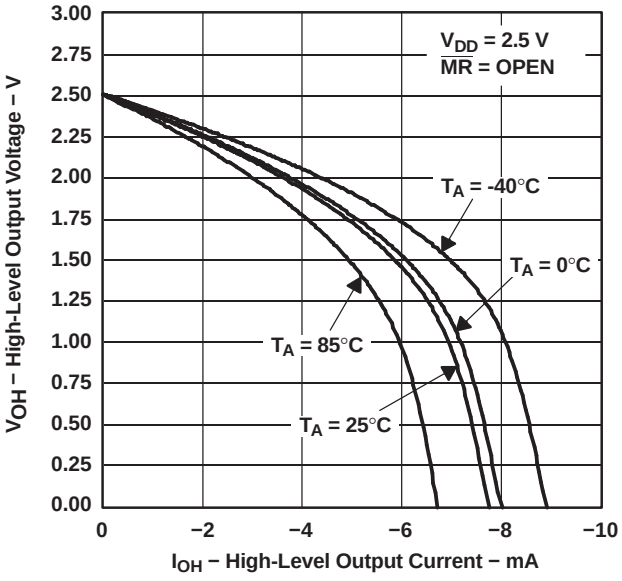


Figure 6.

TYPICAL CHARACTERISTICS (continued)

INPUT CURRENT vs INPUT VOLTAGE AT $\overline{MR}$

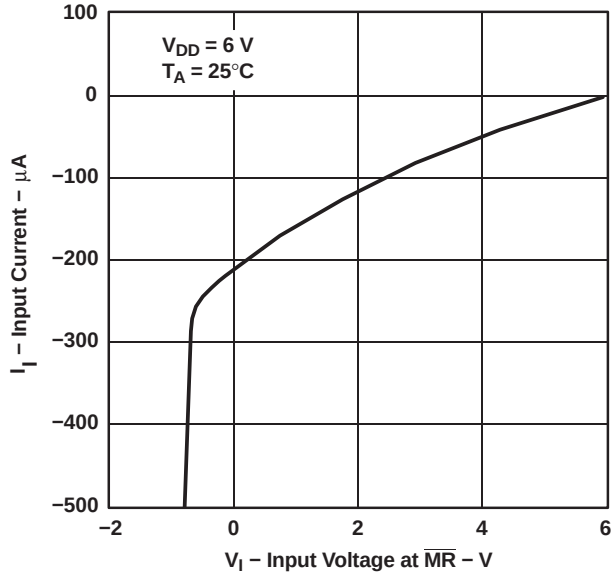


Figure 7.

MINIMUM PULSE DURATION AT V_{DD} vs V_{DD} THRESHOLD OVERDRIVE VOLTAGE

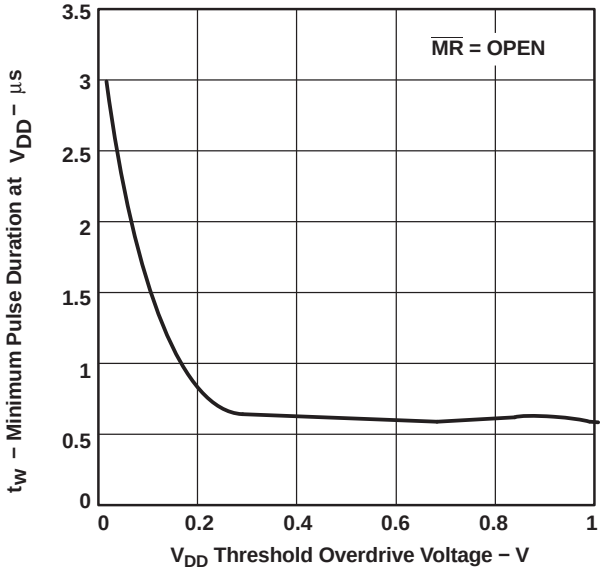


Figure 8.

NORMALIZED INPUT THRESHOLD VOLTAGE vs FREE-AIR TEMPERATURE AT V_{DD}

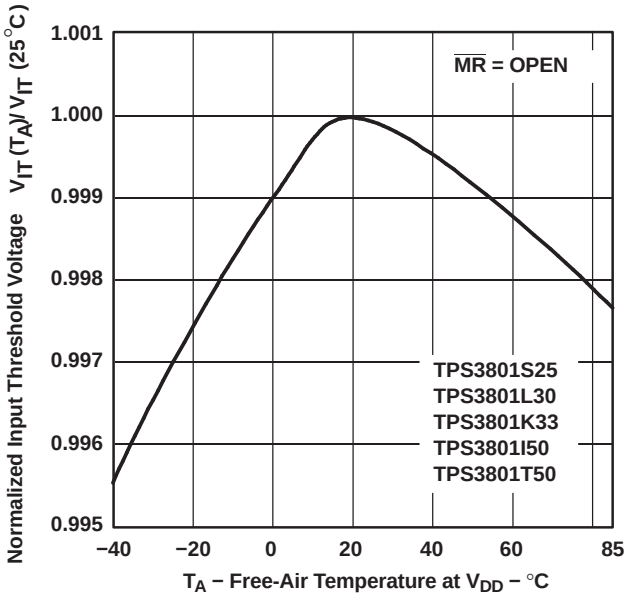


Figure 9.

NORMALIZED INPUT THRESHOLD VOLTAGE vs FREE-AIR TEMPERATURE AT V_{DD}

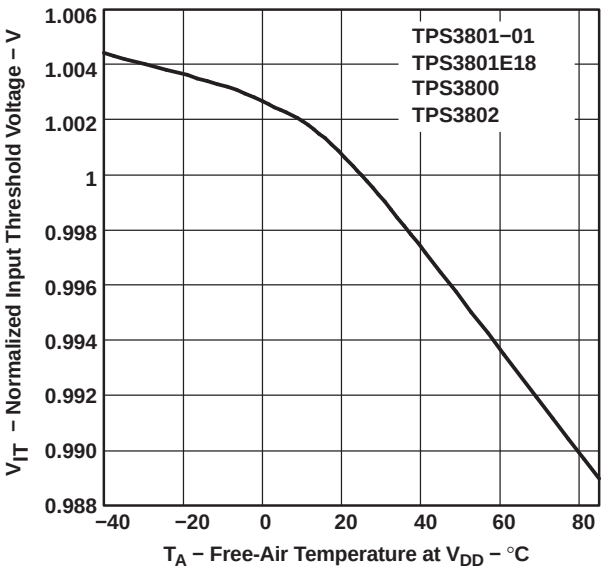


Figure 10.

Changes from Revision D (December 2006) to Revision E **Page**

- Added Pull-up resistor value, $\overline{\text{RESET}}$ to the Recommended Operating Conditions Table 2

PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan (2)	Lead finish/ Ball material (6)	MSL Peak Temp (3)	Op Temp (°C)	Device Marking (4/5)	Samples
TPS3800G27DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARI	Samples
TPS3801-01DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARF	Samples
TPS3801E18DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARE	Samples
TPS3801I50DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NSA	Samples
TPS3801J25DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NJA	Samples
TPS3801K33DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NWA	Samples
TPS3801L30DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	NPA	Samples
TPS3801T50DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	AVI	Samples
TPS3802K33DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ARK	Samples
TPS3802L30DCKR	ACTIVE	SC70	DCK	5	3000	RoHS & Green	NIPDAU	Level-1-260C-UNLIM	-40 to 85	ASA	Samples

(1) The marketing status values are defined as follows:
ACTIVE: Product device recommended for new designs.
LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.
NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.
PREVIEW: Device has been announced but is not in production. Samples may or may not be available.
OBSOLETE: TI has discontinued the production of the device.

(2) **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".
RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.
Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

(3) MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

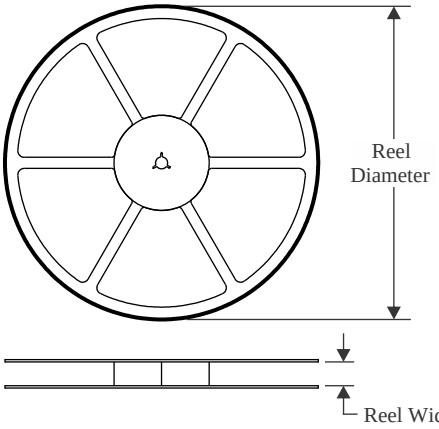
(4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

(5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

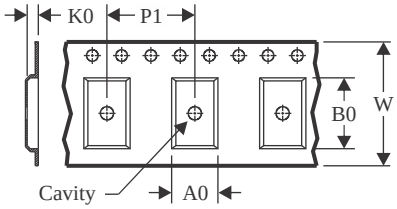
(6) Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

TAPE AND REEL INFORMATION

REEL DIMENSIONS

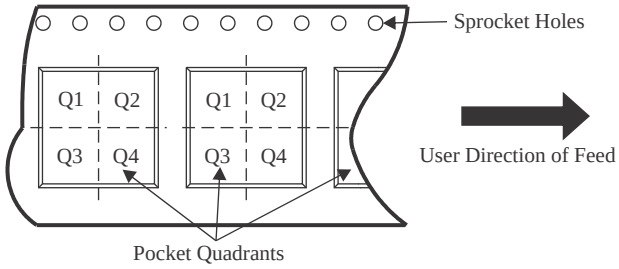


TAPE DIMENSIONS



A0	Dimension designed to accommodate the component width
B0	Dimension designed to accommodate the component length
K0	Dimension designed to accommodate the component thickness
W	Overall width of the carrier tape
P1	Pitch between successive cavity centers

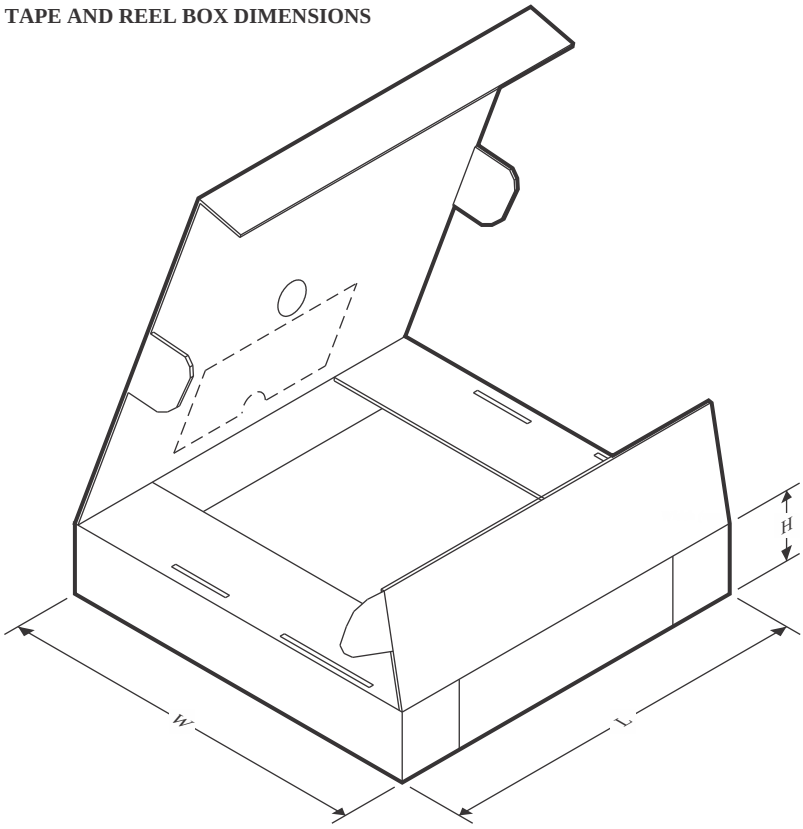
QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



*All dimensions are nominal

Device	Package Type	Package Drawing	Pins	SPQ	Reel Diameter (mm)	Reel Width W1 (mm)	A0 (mm)	B0 (mm)	K0 (mm)	P1 (mm)	W (mm)	Pin1 Quadrant
TPS3800G27DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801-01DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801E18DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801I50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801J25DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3
TPS3802K33DCKR	SC70	DCK	5	3000	178.0	9.0	2.4	2.5	1.2	4.0	8.0	Q3
TPS3802L30DCKR	SC70	DCK	5	3000	180.0	8.4	2.41	2.41	1.2	4.0	8.0	Q3

TAPE AND REEL BOX DIMENSIONS



*All dimensions are nominal

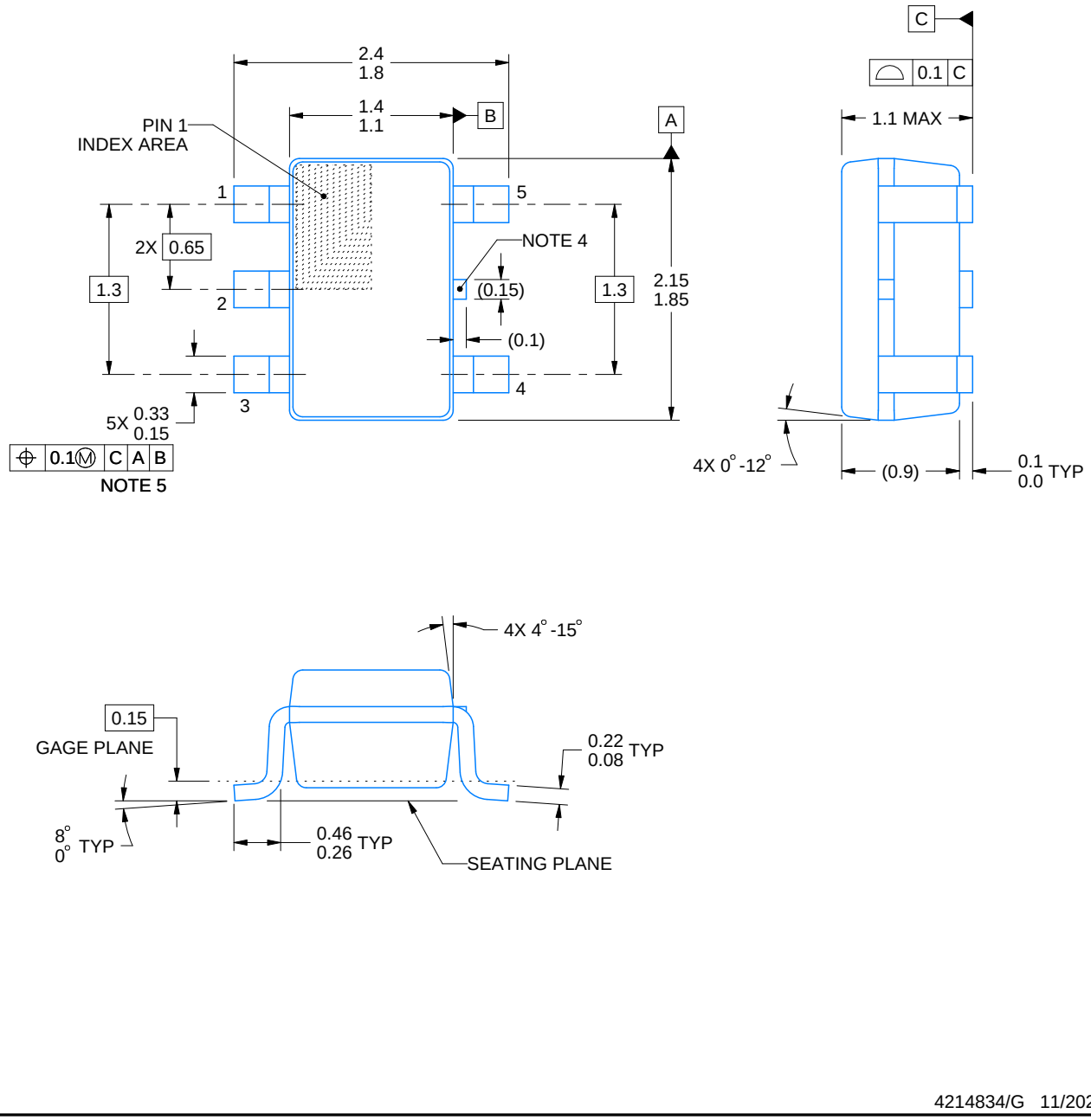
Device	Package Type	Package Drawing	Pins	SPQ	Length (mm)	Width (mm)	Height (mm)
TPS3800G27DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801-01DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801E18DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801I50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801J25DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3801T50DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3801T50DCKR	SC70	DCK	5	3000	183.0	183.0	20.0
TPS3802K33DCKR	SC70	DCK	5	3000	180.0	180.0	18.0
TPS3802L30DCKR	SC70	DCK	5	3000	183.0	183.0	20.0

PACKAGE OUTLINE

DCK0005A

SOT - 1.1 max height

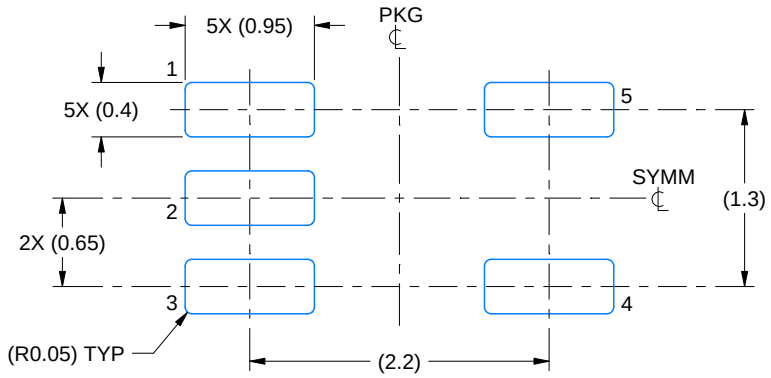
SMALL OUTLINE TRANSISTOR



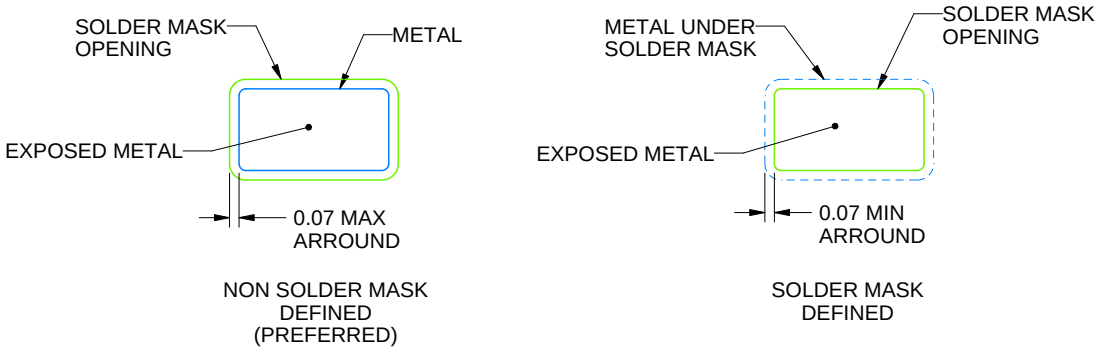
4214834/G 11/2024

NOTES:

1. All linear dimensions are in millimeters. Any dimensions in parenthesis are for reference only. Dimensioning and tolerancing per ASME Y14.5M.
2. This drawing is subject to change without notice.
3. Refernce JEDEC MO-203.
4. Support pin may differ or may not be present.
5. Lead width does not comply with JEDEC.
6. Body dimensions do not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.25mm per side



LAND PATTERN EXAMPLE
EXPOSED METAL SHOWN
SCALE:18X

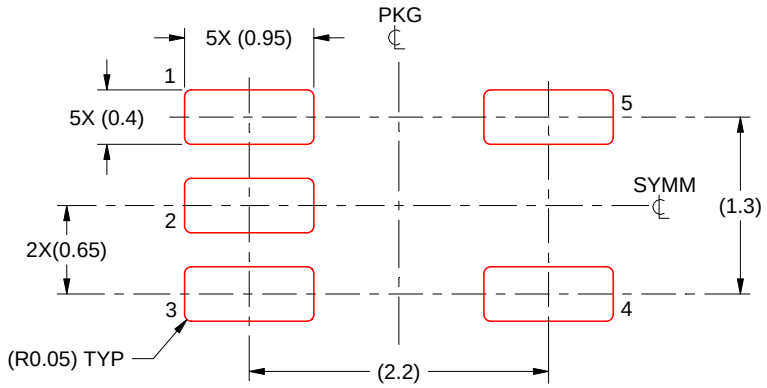


SOLDER MASK DETAILS

4214834/G 11/2024

NOTES: (continued)

7. Publication IPC-7351 may have alternate designs.
8. Solder mask tolerances between and around signal pads can vary based on board fabrication site.



SOLDER PASTE EXAMPLE
BASED ON 0.125 THICK STENCIL
SCALE:18X

4214834/G 11/2024

NOTES: (continued)

9. Laser cutting apertures with trapezoidal walls and rounded corners may offer better paste release. IPC-7525 may have alternate design recommendations.
10. Board assembly site may have different recommendations for stencil design.

IMPORTANT NOTICE AND DISCLAIMER

TI PROVIDES TECHNICAL AND RELIABILITY DATA (INCLUDING DATA SHEETS), DESIGN RESOURCES (INCLUDING REFERENCE DESIGNS), APPLICATION OR OTHER DESIGN ADVICE, WEB TOOLS, SAFETY INFORMATION, AND OTHER RESOURCES “AS IS” AND WITH ALL FAULTS, AND DISCLAIMS ALL WARRANTIES, EXPRESS AND IMPLIED, INCLUDING WITHOUT LIMITATION ANY IMPLIED WARRANTIES OF MERCHANTABILITY, FITNESS FOR A PARTICULAR PURPOSE OR NON-INFRINGEMENT OF THIRD PARTY INTELLECTUAL PROPERTY RIGHTS.

These resources are intended for skilled developers designing with TI products. You are solely responsible for (1) selecting the appropriate TI products for your application, (2) designing, validating and testing your application, and (3) ensuring your application meets applicable standards, and any other safety, security, regulatory or other requirements.

These resources are subject to change without notice. TI grants you permission to use these resources only for development of an application that uses the TI products described in the resource. Other reproduction and display of these resources is prohibited. No license is granted to any other TI intellectual property right or to any third party intellectual property right. TI disclaims responsibility for, and you will fully indemnify TI and its representatives against, any claims, damages, costs, losses, and liabilities arising out of your use of these resources.

TI’s products are provided subject to TI’s Terms of Sale or other applicable terms available either on ti.com or provided in conjunction with such TI products. TI’s provision of these resources does not expand or otherwise alter TI’s applicable warranties or warranty disclaimers for TI products.

TI objects to and rejects any additional or different terms you may have proposed.

Mailing Address: Texas Instruments, Post Office Box 655303, Dallas, Texas 75265